

Date: July 14, 2005



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

1450, Alexandria, VA 22313-1450.

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Patent Application

Applicant(s): F.A. Baiocchi et al.

Case:

2-8-2-3

Serial No.:

10/697,757

Filing Date:

October 30, 2003

Group:

2818

Examiner:

Thinh T. Nguyen

Title:

Enhanced Substrate Contact

for a Semiconductor Device

AMENDMENT TRANSMITTAL

Mail Stop Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

Submitted herewith is the following document relating to the above-identified patent application:

(1) Amendment and Response to Office Action.

There is no additional fee due in conjunction with the Amendment. In the event of any nonpayment or improper payment of a required fee, the Commissioner is hereby authorized to charge or to credit Ryan, Mason & Lewis, LLP Deposit Account No. 50-0762 as required to correct the error.

Respectfully submitted,

Date: July 14, 2005

Wayne L. Ellenbogen

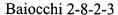
Reg. No. 43,602

Attorney for Applicant(s) Ryan, Mason & Lewis, LLP

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AMENDMENT AND RESPONSE TO OFFICE ACTION

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

In response to the non-final Office Action dated April 14, 2005, please amend the aboveidentified application as follows: